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(54) **ELECTRONIC EQUIPMENT DATA CENTER AND SERVER CO-LOCATION FACILITY CONFIGURATIONS AND METHOD OF USING THE SAME**

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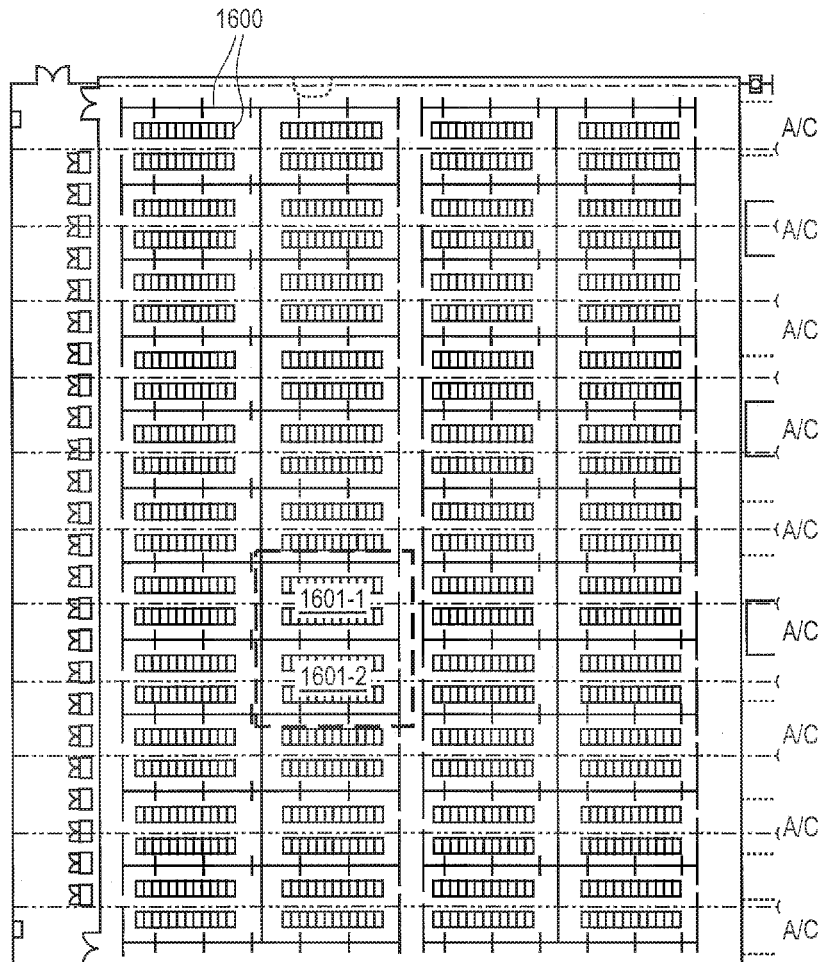
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(57) **ABSTRACT**

Described herein is an integrated data center that provides for efficient cooling, as well as efficient wire routing, and in particular a configuration in which electronic equipment cabinets are arranged in rows within thermal compartments where the cabinets may be rolled in and out of place as required and a frame supports thermal shields of the thermal compartment.



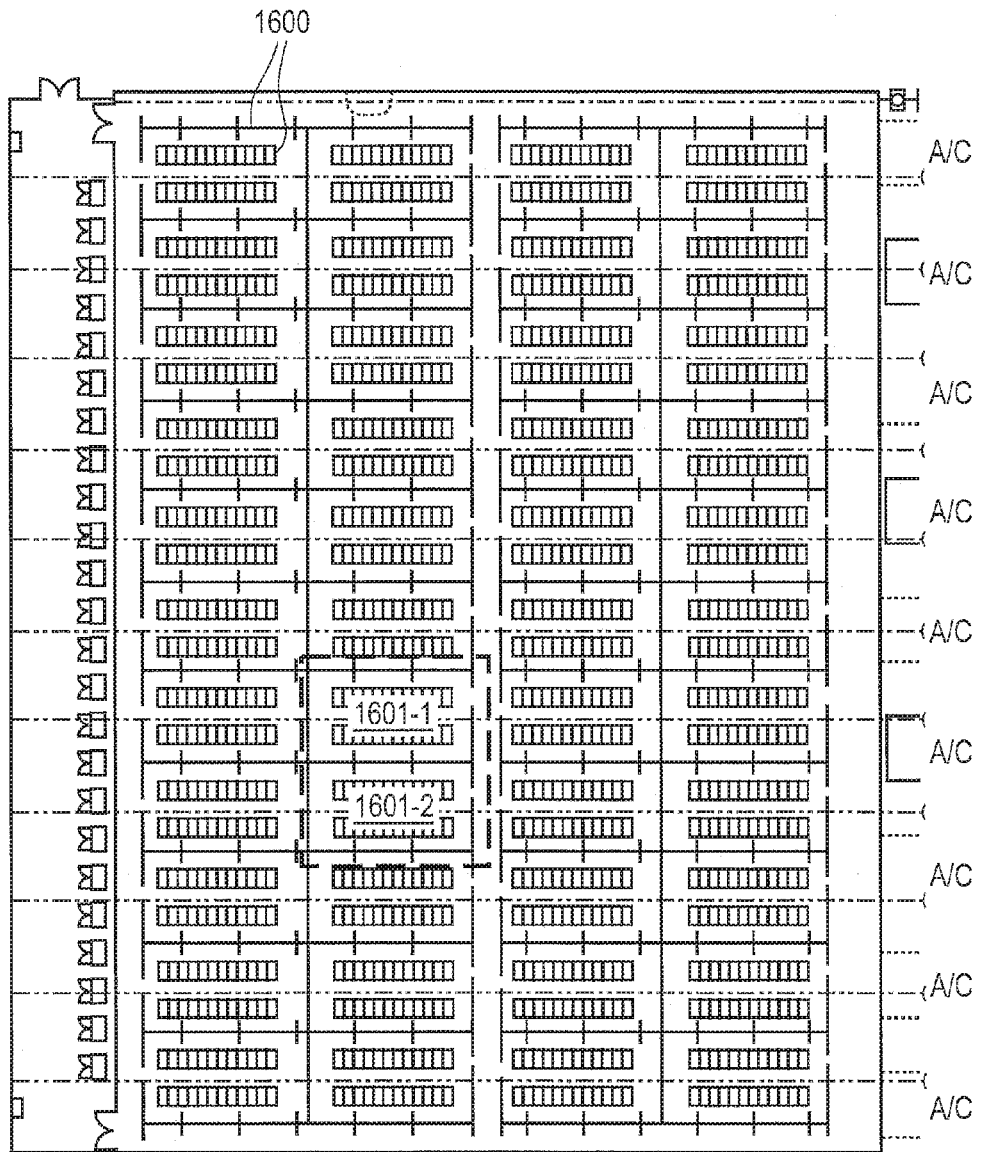


FIG. 1A1

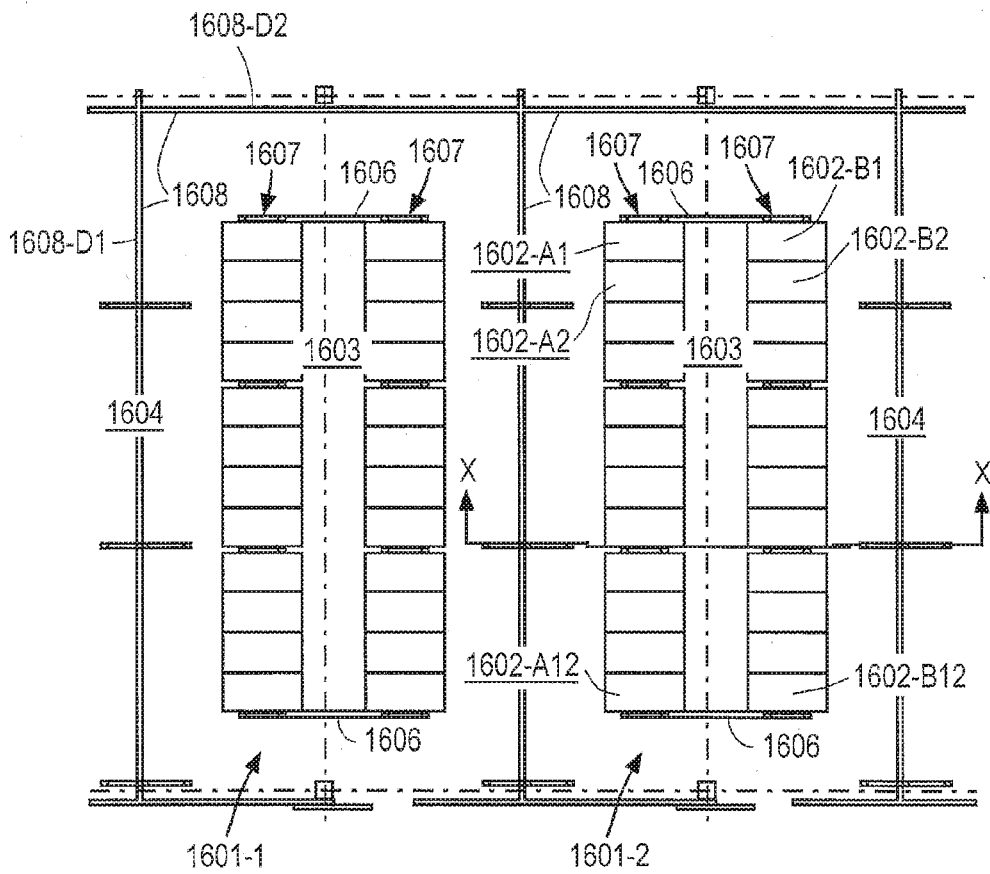


FIG. 1A2

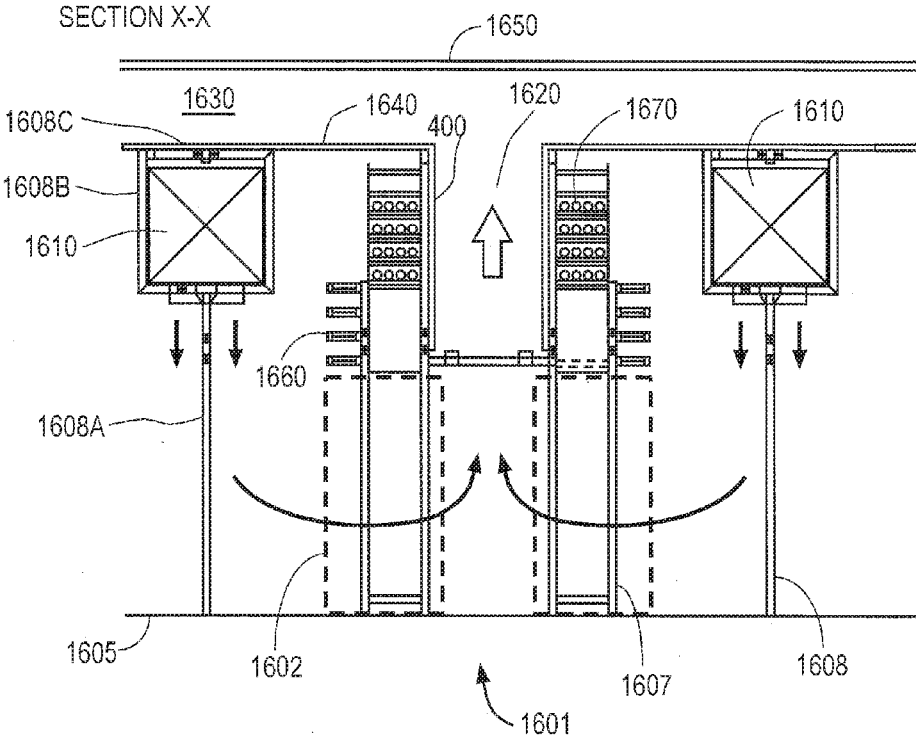


FIG. 1B

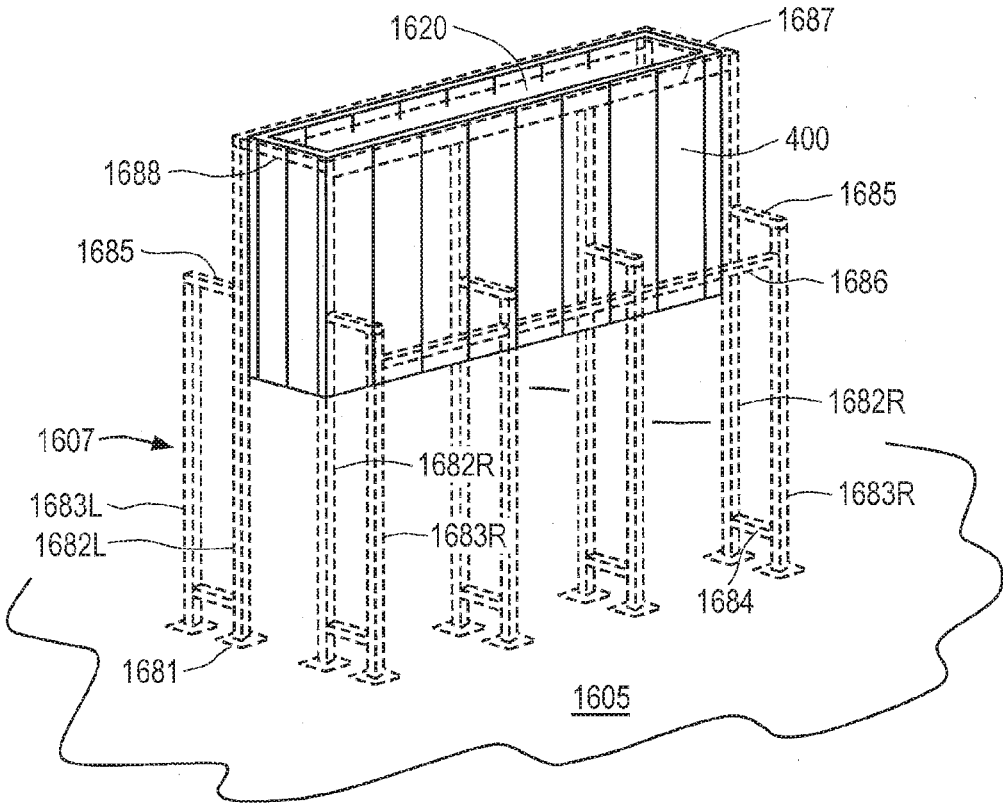


FIG. 2

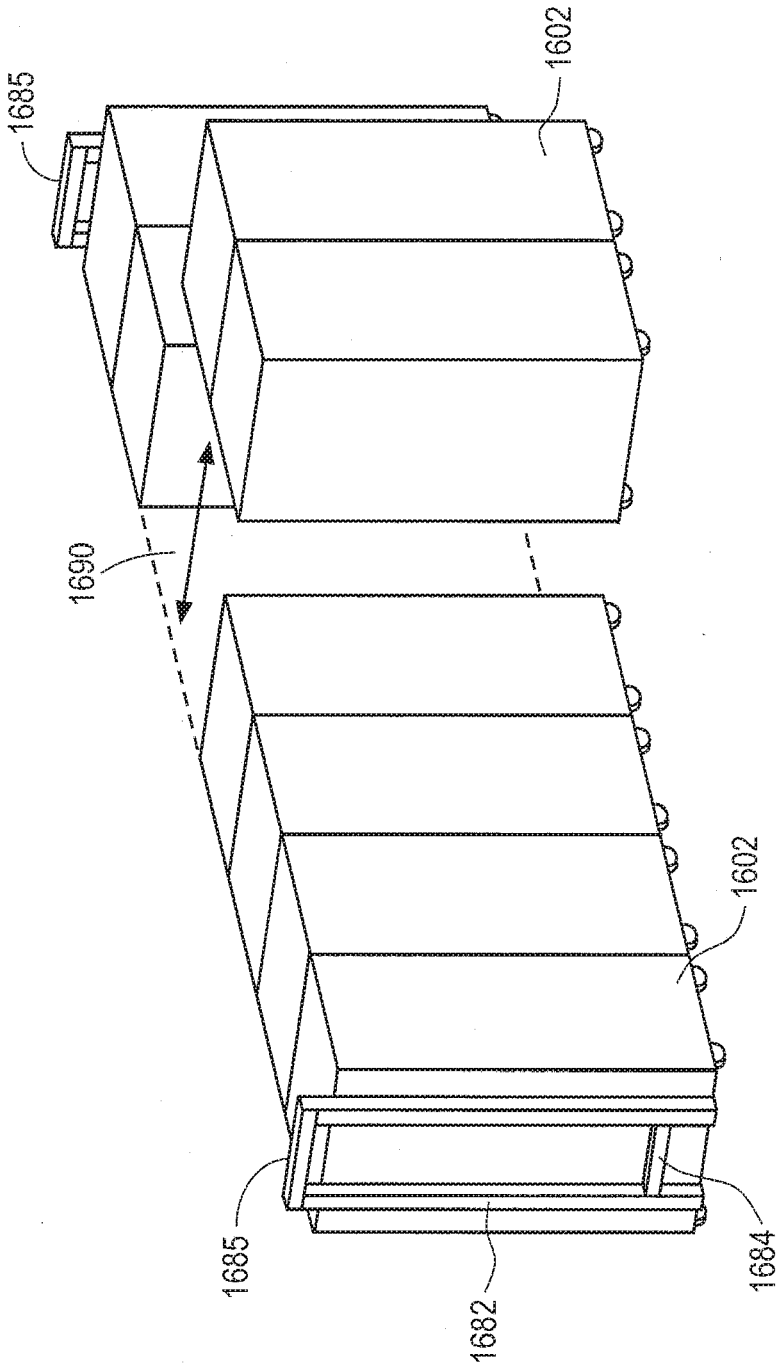


FIG. 3

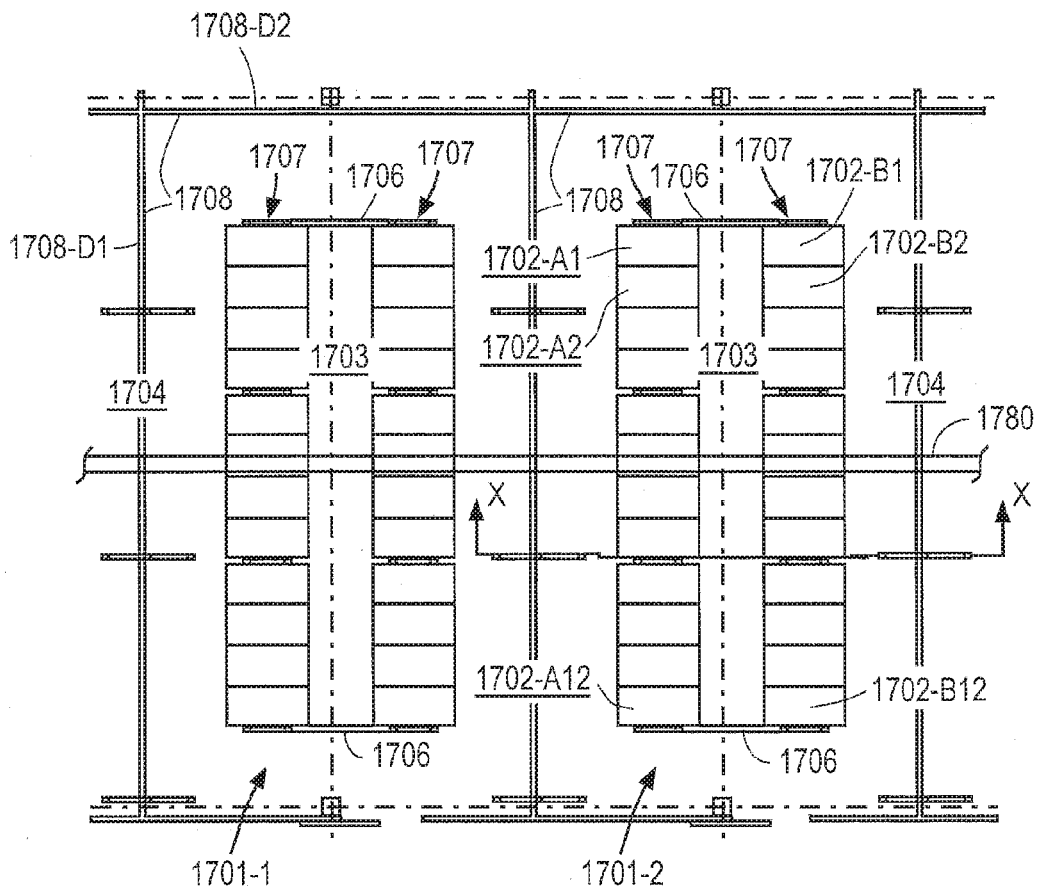


FIG. 4A

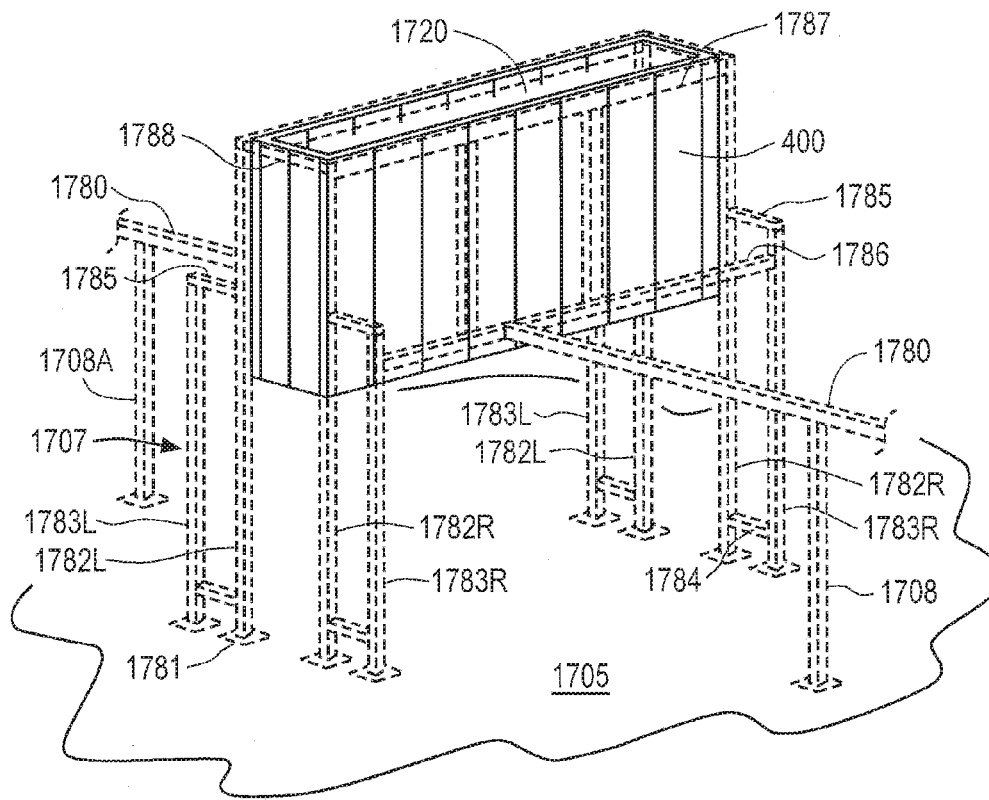


FIG. 5

**ELECTRONIC EQUIPMENT DATA CENTER
AND SERVER CO-LOCATION FACILITY
CONFIGURATIONS AND METHOD OF
USING THE SAME**

BACKGROUND

[0001] Field of the Related Art

[0002] A cabinet cluster support structure for an electronic equipment data center or co-location facility design is described.

[0003] Background

[0004] Data centers and server co-location facilities are well-known. In such facilities, rows of electronics equipment, such as servers, typically owned by different entities, are stored. In many facilities, cabinets are used in which different electronics equipment is stored, so that only the owners of that equipment, and potentially the facility operator, have access therein. In many instances, the owner of the facilities manages the installation and removal of servers within the facility, and is responsible for maintaining utility services that are needed for the servers to operate properly. These utility services typically include providing electrical power for operation of the servers, providing telecommunication ports that allow the servers to connect to transmission grids that are typically owned by telecommunication carriers, and providing air-conditioning services that maintain temperatures in the facility at sufficiently low levels for reliable operation.

[0005] There are some well-known common aspects to the designs of these facilities. For example, it is known to have the electronic equipment placed into rows, and further to have parallel rows of equipment configured back-to back so that each row of equipment generally forces the heat from the electronic equipment toward a similar area, known as a hot aisle, as that aisle generally contains warmer air that results from the forced heat from the electronics equipment. In the front of the equipment is thus established a cold aisle.

[0006] There are different systems for attempting to collect hot air that results from the electronics equipment, cooling that hot air, and then introducing cool air to the electronics equipment. These air-conditioning systems also must co-exist with power and communications wiring for the electronics equipment. Systems in which the electronics equipment is raised above the floor are well-known, as installing the communications wiring from below the electronics equipment has been perceived to offer certain advantages. Routing wiring without raised floors is also known—though not with systematic separation of power and data as described herein.

[0007] In the air conditioning units that are used in conventional facility systems, there are both an evaporator unit and a condenser unit. The evaporator units are typically located inside a facility and the condenser units are typically disposed outside of the facility. These units, however, are not located in standardized, accessible and relatively convenient positions relative to the facility should any of the units need to be accessed and/or removed for repair or replacement. Further, these units are not themselves created using an intentionally transportable design.

[0008] In conventional facilities, wiring for electrical power and cabling for data is typically routed in an ad-hoc manner. More recently, systems for a more uniform system of wiring have been proposed. Nonetheless, there is still needed an apparatus that can provide for local wiring within

a cabinet cluster, as well as for wiring that must be routed to different clusters from a distribution area. Still furthermore, there is the need for an apparatus that can provide for the wiring referred to above, as well as the support for a thermal shield that can create a physical partition to assist with thermal gradients that are desirable within a cabinet cluster.

SUMMARY

[0009] Described are embodiments for an integrated data center that provides for efficient cooling, as well as efficient wire routing.

[0010] In one aspect is described an apparatus for maintaining a configuration of electronic equipment disposed in a plurality of cabinets, for supporting a thermal shield that defines a hot air containment chamber, for supporting a thermal barrier ceiling, for supporting cool air ductwork and for supporting distribution power wires and conduits, electronic equipment power wires and conduits, and communication wiring, the plurality of cabinets disposed on a floor, the floor being within an internal area of a building, the cabinets positioned into two rows that are separated by a hot aisle area so that the electronic equipment disposed in the plurality of cabinets emit heated air in a predetermined direction toward the hot aisle area between the two rows, the apparatus comprising: an interior frame structure that is independent of and not structurally tied to the plurality of cabinets, the interior frame structure including: a first plurality of vertical support brackets disposed only at ends of the two rows, each vertical support bracket being disposed on the floor at one end and assists in supporting the thermal barrier ceiling at another end, wherein the first plurality of vertical support brackets each further support portions of the thermal shield on one side of the first plurality of vertical support brackets at a location above a top of the plurality of cabinets: a first horizontal support bracket disposed above a cabinet height that intersects a middle hot aisle portion so that an area on two opposite sides of each hot aisle where the cabinets can be placed does not have any vertical support brackets disposed therein; a plurality of tiered ladder rack supports, each connected to another side of at least some of the first plurality of vertical support brackets that is opposite the one side, which establish a plurality of different tiers outside of the hot air containment chamber, so that each of the different tiers is adapted to hold the electronic equipment power wires and conduits and the communication wiring, and a plurality of conduit holders for holding a plurality of the distribution power wires and conduits, each of the plurality of conduit holders connected to another side of at least some of the first plurality of vertical support brackets that is opposite the one side, each of the plurality of conduit holder disposed above the plurality of tiered ladder rack supports, each of the plurality of conduit holders being aligned with other ones of the plurality of conduit holders; and a second plurality of vertical support brackets disposed in a row, substantially parallel to the two rows, each second vertical support bracket being disposed on the floor at one end and assists in supporting the thermal barrier ceiling at another end, wherein the second plurality of vertical support brackets each further support portions of the cool air ductwork.

[0011] In another aspect is described a method of configuring a plurality of cabinets having electronic equipment stored therein in building having exterior walls and cool air ductwork comprising the steps of: providing a building have

exterior walls, a floor, a roof with a ceiling below, and an interior room; within the interior room of the building, providing an interior frame structure, the interior frame structure including a plurality of cabinet clusters, each cabinet cluster including a first plurality of vertical support brackets disposed only at ends of the two rows, each vertical support bracket being disposed on the floor at one end, some of the vertical brackets assisting in supporting (1) a portion of a thermal barrier ceiling at another end, the thermal barrier ceiling being disposed below the ceiling and creating an airspace between the ceiling and the thermal barrier ceiling, and (2) a hot containment chamber, the hot containment chamber being contiguous with the thermal barrier ceiling and providing an opening into the airspace, with a sealed chamber through which warm air rises within a hot air aisle associated with the cabinet cluster; a first horizontal support bracket disposed above a cabinet height that intersects a middle hot aisle portion so that an area on two opposite sides of each hot aisle where the cabinets can be placed does not have any vertical support brackets disposed therein; and a second plurality of vertical support brackets disposed in a row, substantially parallel to the two rows, each second vertical support bracket being disposed on the floor at one end and assists in supporting another portion of the thermal barrier ceiling at another end, wherein the second plurality of vertical support brackets each further support portions of the cool air ductwork below the thermal barrier ceiling; providing a plurality of cabinets, the plurality of cabinets being disposed in two rows, below and adjacent to the hot containment chamber, thereby creating the hot aisle between the two rows; providing a thermal cabinet panels in an opening within the two rows where the plurality of cabinets are disposed to seal the hot aisle; and providing a thermal partition at each of two ends of the two rows to further seal the hot aisle.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] These and other aspects and features will become apparent to those of ordinary skill in the art upon review of the following description of specific embodiments of the invention in conjunction with the accompanying figures, wherein:

[0013] FIG. 1A1-2 illustrate top views of a floor design used in the data center or co-location facility.

[0014] FIG. 1B illustrates a cross-sectional view along X-X from FIG. 1A2.

[0015] FIG. 2 illustrates a perspective view of part of the support frame and thermal shields of the data center of FIGS. 1A2 & 1B.

[0016] FIG. 3 illustrates a perspective view of a group of movable equipment cabinets, with one cabinet rolled out, according to embodiments.

[0017] FIG. 4A illustrates a top view of a floor design used in the data center or co-location facility.

[0018] FIG. 4B illustrates a cross-sectional view along X-X from FIG. 4A.

[0019] FIG. 5 illustrates a perspective view of part of the support frame and thermal shields of the data center of FIGS. 4A-4B.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0020] Described are data center or co-location facility designs and methods of making and using the same. The data

center or co-location facility designs have certain features that will be apparent herein and which allow many advantages in terms of efficient use of space, efficient modular structures that allow for efficiency in the set-up of co-location facility and the set-up of the electronics equipment in the facility, as well as efficient air-conditioning within the facility. Each of these features has aspects that are distinct on their own, and combinations of these features also exist that are also unique.

[0021] FIGS. 1A1-2 & 1B show different views of a portion of a data center or co-location facility.

[0022] FIG. 1A1 shows a top view of a preferred data center floor, with an interior frame structure **1600** used to form the structures, described hereinafter, that support an array of cabinet clusters **1601**, two of which are identified as **1601-1** and **1601-2**, and which are then shown in further detail in FIG. 1A2. In this specific embodiment in FIG. 1A1, a 4x11 array of cabinet clusters is illustrated, though the number and shape thereof can vary, as explained further herein. It is noted that this top view also illustrates, along the entire left edge, a row of PDUs, which are internal within the data center, as well as a row of A/C units, which are external to the data center. Cool air is provided by cool-air ductwork from the external A/C units to the cabin clusters using cool-air ductwork **1610** illustrated in FIG. 1B, which ductwork preferably spans an entire row of four different cabinet clusters, as shown in this specific embodiment. As also shown in FIG. 1B, there exists a thermal barrier ceiling **1640**, from which ceiling air **1630** the hot air then flows to the air handling system A/C, and there is a tight seal so that the only openings to the ceiling air **1630** are using the hot air containment chamber **162**, formed as described further herein, above each hot-aisle **1604** associated with each cabinet cluster **1601**.

[0023] In certain embodiments, parallel rows of equipment cabinets **1602** are arranged in clusters, and further configured so as to allow the cabinets to be rolled in and out of place as required, as well as around load-bearing posts of the interior frame structure **1600**, without interference by wiring and other components. It is thus apparent that a significant aspect is that the equipment cabinets are independent of, and not structurally a part of the interior frame structure **1600**, which allows for a host of advantages and efficiencies. The interior facility shown in FIGS. 1A1-2 and 1B may be integrated with the air handling systems described in U.S. Utility application Ser. No. 12/384,109 entitled "Electronic Equipment Data Center or Co-location Facility Designs and Methods of Making and Using the Same" filed on Mar. 30, 2009, incorporated by reference in full herein, wherein the condenser air conditioning units and heat expulsion chambers are either disposed within or outside the exterior walls of the facility. Furthermore, the interior facility shown in FIGS. 1A1-2 and 1B may include aspects of one or more of the cable and conduit routing system configurations as described in U.S. Utility application Ser. No. 12/384,109, and expanded upon in more detail below.

[0024] The interior facility shown in FIGS. 1A1-2 and 1B also includes a cabinet clusters **1601**, each cabinet cluster **1601** configured to provide direct hot air exhaust from the electrical equipment toward the hot aisle **1603** associated therewith. Air flows in which the cool air moves efficiently through the electronic equipment cabinets **1602** into the hot aisles **1603** from where it is exhausted through a hot air

containment chamber **1620** and into an upper ceiling area **1630**, which is lowerly bounded by the upper surface of the thermal barrier ceiling **1640**, from which ceiling air **1630** the hot air then flows to the an air handling system (A/C shown in FIG. **1A1**). The air flow through the electronic equipment cabinets is configured and controlled to provide efficient cooling of the electronic equipment while also cooling the facility in an environmentally efficient manner.

[**0025**] FIG. **1A2** also illustrates that the parallel rows of electronic equipment cabinets **1602** are configured on each side of a hot aisle **1603**, with the electronic cabinets and equipment therein being arranged in a back-to-back configuration, such that for example, the back of cabinet **1602A1** faces the back of cabinet **1602B1**. While twelve (12) cabinets **1602** per row are shown, this number is illustrative only. Further a square cabinet configuration cluster or other variants that include a hot aisle are within the intended scope of the invention.

[**0026**] The ends of each aisle are closed off by a solid thermal barrier partition **1606** that attaches to the support frames **1607**, described further hereinafter. One of the two partitions **1606** within each cabinet cluster **1601** preferably includes a door for access to the corresponding hot aisle **1603**. A row of cabinets on each side of a hot aisle forms the cabinet cluster **1601**. Each cabinet cluster **1601** has a cold aisle **1604** on either side, typically shared in common with an adjacent cabinet cluster **1601**.

[**0027**] The floor **1605** of the facility may be marked to explicitly show the various areas of the facility. For example, the center area of the hot aisle **1603** may be marked by tile, paint, tape or otherwise. The typical dimensions of the central area are typically in the range of 2'-4' across the width, with a row length corresponding to the number of electronic cabinets in the row. Marking with tiles is preferable as the marking will last, and tiles that are red in color, corresponding to the generation of heat, have been found preferable. The areas where rows of cabinets **1602** are positioned may be marked in another manner, such as using a grey tile that is different in color from the center area. Furthermore, the floor areas outside of the cabinets and hot aisle may be marked in yet a different manner, such as using a light grey tile. The placement of these markings for the different areas on the floor of the facility, preferably prior to moving any equipment onto the floor, allows for a visual correspondence on the floor of the various hot and cold aisles. In particular, when pushing cabinets into place, the cabinets will sit on a grey tile, facing a red tiled hot aisle at the back and a light grey area that is for the front of the cabinet that will face the cold aisle, hence the correct position of a cabinet will be readily apparent.

[**0028**] Furthermore, FIG. **1A2** shows the interior frame structure **1600**, which includes support frames **1607** for supporting the thermal barrier **400** associated with each cabinet cluster **1601**, the various support racks and conduits described herein, and the thermal barrier ceiling **1640**, and also support frame **1608** for supporting the cold air ducts and the thermal barrier ceiling **1640**. The frames **1607** for the cabinet clusters are preferably bolted to the floor **1605**. In the example shown in FIG. **1A2**, the frames **1607** divide up each row into three equal groups of cabinets, and include therein power and telecommunications equipment that is used to then service other electronic equipment within the cabinet cluster, as described in the applications incorporated by reference herein. (Such a group of cabinets is shown in FIG.

3.) The cold air ducts which are supported by frames **1608** that run parallel to the rows of cabinets and are also preferably bolted to the floor **1605**. In a preferred embodiment, they are positioned directly above the cold aisles **1604**, though other overhead positions will also work. The interior frames **1607** and frame **1608** may be made of structurally sound materials, such as steel with a welded construction of the various parts as described, molded plastic, or other materials. Further details of the frames **1607** and frame **1608** are shown in FIGS. **1B** & **2**.

[**0029**] FIG. **1B** illustrates a cross-sectional view along line X-X from FIG. **1A**. The figure shows floor **1605**, thermal barrier ceiling **1640** and actual ceiling **1650**. The thermal barrier ceiling **1640** and the actual ceiling **1650** are configured to have a gap that is preferably at least 1.5-3 feet and advantageously at least 15 feet, as the higher the ceiling the more the warm air rises (and thus also stays further away from the equipment in the cabinets **1602**). The thermal barrier ceiling **1640** is preferably made of insulated tiles or panels, with a thickness of at least 1.5"-4.0". The insulation value of the tiles/panels is preferably at least an R5-R19. These tiles/panels are held in position by the interior frame **1600**, rather than being hung by a suspended ceiling as is conventionally done, which reduces the load to the roof. The tiles/panels for the thermal barrier ceiling **1650** are preferably are insulated sandwich construction with a metal skin on the top side and bottom side with a thickness of 18-22 ga. which exhibit a greater mass than many conventional tiles—as here it is desired to use tiles that provide effective thermal insulation between the hot air and cold air regions. With respect to these tiles/panels, adjacent ones interlocking to provide even further strength and an air tight seal on both longitudinal seams. The section view illustrated in FIG. **1B** passes through one of the frames **1607**, which has two rows of cabinets associated therewith, thereby providing the cabinet cluster **1601** that has a hot aisle **1603** within a centerline thereof. The position of cabinets **1602** immediately behind the plane of the section illustration are indicated by dashed lines. Also shown are single arrows that illustrate the cool air flow from the cold air supply ducts **1610**, through the electronic equipment cabinets **1602** where the air is heated as it cools the electronic equipment and then the double arrows show the hot air moving upward from the hot air containment chamber **1620** formed by the thermal shields **400** to the region between the thermal barrier ceiling **1640** and the actual ceiling **1650**. Note that the thermal shields **400** bound the hot air containment chamber **1620** and that there is an air-tight seal between the top of the thermal shields and the thermal barrier ceiling **1640** to ensure all of the hot air flows into the ceiling space **1630** from where it is exhausted and that none of the hot air leaks back into the cold aisles and adjacent areas of the facility floor. The hot air flows within the ceiling area **1630** to an exhaust channel area from where the hot air may be either exhausted outside the building, chilled and then recirculated, or a combination of external exhaust and recirculation, as described in U.S. Utility application Ser. No. 12/384,109 mentioned previously.

[**0030**] Though the arrows for cool air in FIG. **1B** are directed straight downward from the cold air supply duct **1610**, the vents associated with the cold air supply duct themselves can be adjusted to allow for directional downward flow at various angles. In a preferred embodiment, each of the vents has a remote-controlled actuator that

allows for the offsite control of the vents, both in terms of direction and volume of air let out of each cold air supply vent. This allows precise control such that if a particular area is running hot, this can be detected (using detectors not shown), and then adjusted for by supplying more cold air directed thereto.

[0031] Furthermore, as described in detail in U.S. Utility application Ser. No. 12/384,109 mentioned previously, ladder racks **1660** and conduit holders **1670** are preferably attached to the frame **1607** for supporting various cables, wires and conduits including power spines and telecommunications wiring. The conduit holders **1670** are shown, as an example to have room for 4 conduits to run wiring or cabling therethrough. As an alternative to the conduit holders **1670**, conduit clamps for conduit holding, and holding of the wires or cables within the conduits, may be used, as also described in U.S. Utility application Ser. No. 12/384,109.

[0032] Also shown in FIG. 1B are certain vertical posts and frame elements of the frame **1608** for support of the cold air supply ducts **1610** and the thermal barrier ceiling **1640**. The vertical posts of the frame **1608** are preferably bolted to the floor **1605** at the lower end and provide support for the thermal barrier ceiling **1640** at the upper end. The frame **1608** include a plurality of support pillars **1608A** attached to a square frame **1608B** within which the cold air supply ducts **1610** are supported, as shown in FIG. 1B, as well as a thermal barrier mount **1608C** on which the thermal barrier ceiling **1640** rests. The frame **1608** also includes other vertical posts that are used to support horizontal beams on which the thermal barrier ceiling **1640** preferably rests, such as horizontal beams **1608D1** and **1608D2** illustrated in FIG. 1A2, which have a vertical post at their intersection.

[0033] FIG. 2 shows the primary load-bearing elements of one of the frames **1607** and thermal shields **400** attached thereto for one cabinet cluster **1601**—as also shown in FIGS. 1A2 & 1B. For ease of illustration the frame on the back side of the cabinet cluster, from the perspective of the figure, is not shown. The frame **1607** is preferably bolted to the floor **1605** by plates **1681** and provides support for the thermal shields **400** which define the hot air containment chamber **1620** which channels the hot air into the ceiling space for exhausting, as described above, as well as provides a support for the thermal barrier ceiling **1640**. The frame **1607** is comprised of vertical support brackets **1682 R** and **1682L** (for Right and Left) and **1683 R** and **1683 L** and horizontal support brackets **1684-1688**, with vertical support brackets **1682 R** and **1682 L** providing support for horizontal support brackets **1687** and **1688** as well as for the thermal barrier **1640**. The thermal shields **400** are bolted to the members **1682**, **1687** and **1688**. Various ladder racks (shown in FIG. 1A) as well as conduit holders (**1670** in FIG. 1A2) are preferably attached to vertical support brackets **1682R** and **1682L**, as described above with reference to FIG. 1B, preferably above the horizontal member **1685**. As described above, the frame **1607** may be made of structurally sound material, such as steel with a welded construction of the various parts as described, molded plastic, or other materials. The configuration of the frame **1607** shown in FIGS. 1A1-2, 1B and 2 is only one example of a frame configuration that can support the thermal barrier, the thermal shields and the conduits while allowing the cabinets in the cabinet cluster to be moved in and out of place—and as such other configurations of the frame are envisaged which can provide the support desired in this embodiment.

[0034] FIG. 3 illustrates a perspective view (not to scale) of part of a group of movable equipment cabinets **1602**, with one cabinet rolled out into the cold aisle, according to embodiments described herein. Cabinets typically have a width of 19"-24", though they can be as large as 30". If an area does not have a cabinet within it, a thermal barrier cabinet panel **1690** (shown in dotted line) the size of the cabinet removed is preferably inserted to avoid hot air from the hot-air aisle escaping back toward a cold aisle, rather than to the above hot air containment chamber **1620** and into the ceiling area **1630**. The thermal barrier cabinet panel **1690** has insulating characteristics like that of the thermal shield described above. This same type of thermal barrier cabinet panel **1690** can be used if cabinets of various sizes are used, and at an end an area needs to be closed off. The group of cabinets is configured in a row between support beams **1682** and **1683** of the frame **1607**, as described above with reference to FIGS. 1A2 and 2. The arrow shows the direction of movement of the cabinet in and out of the row. In a preferred embodiment, the cabinets **1602** are provided with wheels **1702** for ease of movement, which are also lockable to keep the cabinets in position, though cabinets without wheels can also be used. Although not shown in FIG. 3, the cabinets are typically comprised of a frame supporting electronics within and are covered in wire mesh on the front and the back to allow for air flow through the cabinet, with the sidewalls preferably being sealed to allow the air to flow therethrough.

[0035] FIG. 4A illustrates a top view of a floor design used in the data center or co-location facility. FIG. 4B illustrates a cross-sectional view along X-X from FIG. 4A. FIG. 5 illustrates a perspective view of part of the support frame and thermal shields of the data center of FIGS. 4A-4B. FIGS. 4A-B and 5(e-g) shown another embodiment that corresponds to FIGS. 4A, 4B and 5, with numbering of similar limitations as 17xx whereas in FIGS. 1A2, 1B and 2 the number is 16xx. The difference, however, is that the middle two vertical support brackets **1682 R** and **1682L** (for Right and Left) and **1683 R** and **1683 L** within the hot-aisle are removed, and replaced instead with a structural beam **1780**, which open up the hot aisle to allow for the placement of cabinets more easily, and also provide further support as the various different frames for each cabinet cluster are further connected via the beam to each other, as well as other vertical support posts, as shown.

[0036] Although the embodiments have been particularly described with reference to embodiments thereof, it should be readily apparent to those of ordinary skill in the art that various changes, modifications and substitutes are intended within the form and details thereof, without departing from the spirit and scope thereof. Accordingly, it will be appreciated that in numerous instances some features will be employed without a corresponding use of other features. Further, those skilled in the art will understand that variations can be made in the number and arrangement of components illustrated in the above figures.

What is claimed is:

1. An apparatus for maintaining a configuration of electronic equipment disposed in a plurality of cabinets, for supporting a thermal shield that defines a hot air containment chamber, for supporting a thermal barrier ceiling, for supporting cool air ductwork and for supporting distribution power wires and conduits, electronic equipment power wires and conduits, and communication wiring, the plurality of

cabinets disposed on a floor, the floor being within an internal area of a building, the cabinets positioned into two rows that are separated by a hot aisle area so that the electronic equipment disposed in the plurality of cabinets emit heated air in a predetermined direction toward the hot aisle area between the two rows, the apparatus comprising:

an interior frame structure that is independent of and not structurally tied to the plurality of cabinets, the interior frame structure including:

a first plurality of vertical support brackets disposed only at ends of the two rows, each vertical support bracket being disposed on the floor at one end and assists in supporting the thermal barrier ceiling at another end, wherein the first plurality of vertical support brackets each further support portions of the thermal shield on one side of the first plurality of vertical support brackets at a location above a top of the plurality of cabinets:

a first horizontal support bracket disposed above a cabinet height that intersects a middle hot aisle portion so that an area on two opposite sides of each hot aisle where the cabinets can be placed does not have any vertical support brackets disposed therein;

a plurality of tiered ladder rack supports, each connected to another side of at least some of the first plurality of vertical support brackets that is opposite the one side, which establish a plurality of different tiers outside of the hot air containment chamber, so that each of the different tiers is adapted to hold the electronic equipment power wires and conduits and the communication wiring, and

a plurality of conduit holders for holding a plurality of the distribution power wires and conduits, each of the plurality of conduit holders connected to another side of at least some of the first plurality of vertical support brackets that is opposite the one side, each of the plurality of conduit holder disposed above the plurality of tiered ladder rack supports, each of the plurality of conduit holders being aligned with other ones of the plurality of conduit holders; and

a second plurality of vertical support brackets disposed in a row, substantially parallel to the two rows, each second vertical support bracket being disposed on the floor at one end and assists in supporting the thermal barrier ceiling at another end, wherein the second plurality of vertical support brackets each further support portions of the cool air ductwork.

2. The apparatus according to claim 1 wherein each of the first plurality of vertical support brackets each includes a pair of vertical support members, and each pair of vertical support members are connected together with at least one horizontal member, and are further connected to another pair of vertical support members with another horizontal member;

further including a plurality of horizontal connecting members that connect together adjacent pairs of vertical support members; and

wherein each row of cabinets is positionable underneath one pair of vertical support members.

3. The apparatus according to claim 2 wherein each of the second plurality of vertical support brackets includes a rectangular-shaped support through which the cool air ductwork passes.

4. The apparatus according to claim 1 wherein each of the second plurality of vertical support brackets includes a rectangular-shaped support through which the cool air ductwork passes.

5. The apparatus according to claim 1 wherein the plurality of conduit holders are a plurality of conduit clamps disposed on each of the first plurality of vertical support brackets above the plurality of tiered ladder rack supports.

6. The apparatus according to claim 1 wherein the plurality of conduit holders are disposed on at least one conduit ladder rack support.

7. The apparatus according to claim 1 wherein the plurality of conduit holders are disposed on a plurality of tiered conduit ladder rack supports.

8. The apparatus according to claim 1 further including a plurality of ladder racks, each of the plurality of ladder racks being associated with one of the plurality of tiered ladder rack supports of the plurality of support brackets, such that each of the plurality of ladder racks is horizontally disposed above the cabinets below and provides further support for the electronic equipment power wires and conduits and the communication wiring.

9. A method of configuring a plurality of cabinets having electronic equipment stored therein in building having exterior walls and cool air ductwork comprising the steps of:

providing a building have exterior walls, a floor, a roof with a ceiling below, and an interior room;

within the interior room of the building, providing an interior frame structure, the interior frame structure including a plurality of cabinet clusters, each cabinet cluster including

a first plurality of vertical support brackets disposed only at ends of the two rows, each vertical support bracket being disposed on the floor at one end, some of the vertical brackets assisting in supporting (1) a portion of a thermal barrier ceiling at another end, the thermal barrier ceiling being disposed below the ceiling and creating an airspace between the ceiling and the thermal barrier ceiling, and (2) a hot containment chamber, the hot containment chamber being contiguous with the thermal barrier ceiling and providing an opening into the airspace, with a sealed chamber through which warm air rises within a hot air aisle associated with the cabinet cluster;

a first horizontal support bracket disposed above a cabinet height that intersects a middle hot aisle portion so that an area on two opposite sides of each hot aisle where the cabinets can be placed does not have any vertical support brackets disposed therein; and

a second plurality of vertical support brackets disposed in a row, substantially parallel to the two rows, each second vertical support bracket being disposed on the floor at one end and assists in supporting another portion of the thermal barrier ceiling at another end, wherein the second plurality of vertical support brackets each further support portions of the cool air ductwork below the thermal barrier ceiling;

providing a plurality of cabinets, the plurality of cabinets being disposed in two rows, below and adjacent to the hot containment chamber, thereby creating the hot aisle between the two rows;

providing a thermal cabinet panels in an opening within the two rows where the plurality of cabinets are disposed to seal the hot aisle; and

providing a thermal partition at each of two ends of the two rows to further seal the hot aisle.

10. The method according to claim **11** further including the steps of:

removing one of the cabinets within the two rows, thereby creating a cabinet opening within the two rows; and replacing the removed cabinet with another thermal cabinet panel to fill the cabinet opening.

11. The method according to claim **11** wherein the step of providing the interior frame structure includes providing a plurality of ladder racks and a plurality of conduits at locations that are on an opposite side of some of the vertical support brackets that hold the portions of the thermal shield; and

wherein telecommunications wiring and power wiring are disposed within the plurality of ladder racks and the plurality of conduits, adjacent to the thermal shield.

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